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PATENT
SOEI/0011

JC921 U.S. PTO
10/23/01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

BOX PATENT APPLICATION
Assistant Commissioner for Patents
Washington, D.C. 20231

CERTIFICATE UNDER 37 CFR 1.10	
I hereby certify that this correspondence and the documents referred to as attached therein are being deposited on October 23, 2001 with the United States Postal Service in an envelope as "Express Mail Post Office to Addressee," mailing label No. EL870882485US addressed to: Box Patent Application, Assistant Commissioner for Patents, Washington, D.C. 20231.	
Date 23 Oct 2001	Signature <i>William B. Patterson</i>

Re: Inventor(s): Suzuki, et al.
Title: Method of Forming Film, Method of Manufacturing Semiconductor Device and Film Forming Apparatus

Transmitted herewith is the patent application identified above, including:

- ☒ Specification, claims and abstract 24 Total Pages
- ☒ Drawings ☒ Formal ☐ Informal 12 Total Pages
- ☒ Executed Declaration and Power of Attorney
- ☐ Information Disclosure Statement with List
- ☒ Assignment of the Invention to Applied Materials, Inc.
- ☐ Assignment Recordation Cover Sheet

JC955 U.S. PTO
10/004489
10/23/01

FEE CALCULATION

	NUMBER OF CLAIMS FILED	LESS NUMBER PAID BY BASIC FEE	NUMBER OF EXTRA CLAIMS (Not less than zero)	LARGE ENTITY FEE
Basic Fee				\$740.00
Total Claims	20	- 20 = 0	X \$. =	.00
Independent Claims	3	- 3 = 0	X \$. =	.00
First Presentation of Multiple Dependent Claims +250				-0-
Total Filing Fee Calculation				740.00

- ☒ The Commissioner is hereby authorized to charge 740 to Deposit Account No. 20-0782/SOEI/0011. **A duplicate copy of this transmittal is enclosed.**
- ☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 20-0782/SOEI/0011. **A duplicate copy of this transmittal is enclosed.**
- ☒ Please address all future correspondence to:
MOSER, PATTERSON & SHERIDAN, L.L.P.
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Respectfully submitted,

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UNITED STATES PATENT APPLICATION FOR:

METHOD OF FORMING FILM, METHOD OF MANUFACTURING
SEMICONDUCTOR DEVICE, AND FILM FORMING APPARATUS

INVENTORS:

YOICHI SUZUKI
TSUTOMU SHIMAYAMA

ATTORNEY DOCKET NUMBER: SOEI/0011

CERTIFICATION OF MAILING UNDER 37 C.F.R. 1.10

I hereby certify that this New Application and the documents referred to as enclosed therein are being deposited with the United States Postal Service on October 23, 2001, in an envelope marked as "Express Mail United States Postal Service", Mailing Label No. EK870882485US, addressed to: Assistant Commissioner for Patents, Box PATENT APPLICATION, Washington, D.C. 20231.

William B. Patterson
Signature

William B. Patterson
Name

23 October 2001
Date of signature